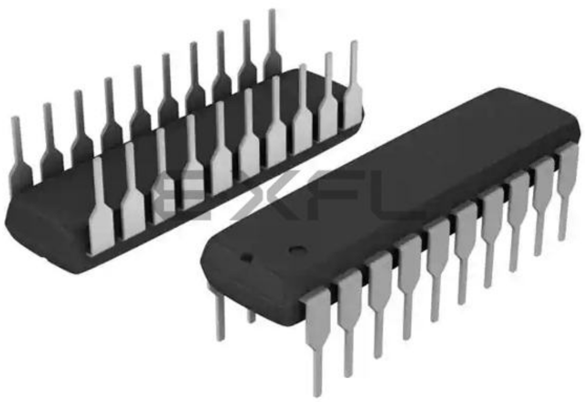
Zilog - Z8F0113PH005EG Datasheet



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	16
Program Memory Size	1KB (1K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0113ph005eg

- 2.7V to 3.6V operating voltage
- Up to thirteen 5V-tolerant input pins
- 8-, 20-, and 28-pin packages
- 0°C to +70°C and –40°C to +105°C for operating temperature ranges

Part Selection Guide

Table 1 lists the basic features and package styles available for each device within the Z8 Encore! XP® F0823 Series product line.

Table 1. F0823 Series Family Part Selection Guide

Part Number	Flash (KB)	RAM (B)	I/O	ADC Inputs	Packages
Z8F0823	8	1024	6–22	4–8	8-, 20-, and 28-pins
Z8F0813	8	1024	6–24	0	8-, 20-, and 28-pins
Z8F0423	4	1024	6–22	4–8	8-, 20-, and 28-pins
Z8F0413	4	1024	6–24	0	8-, 20-, and 28-pins
Z8F0223	2	512	6–22	4–8	8-, 20-, and 28-pins
Z8F0213	2	512	6–24	0	8-, 20-, and 28-pins
Z8F0123	1	256	6–22	4–8	8-, 20-, and 28-pins
Z8F0113	1	256	6–24	0	8-, 20-, and 28-pins

Table 6. Z8 Encore! XP F0823 Series Program Memory Maps (Continued)

Program Memory Address (Hex)	Function
Z8F0123 and Z8F0113 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–0005	WDT Interrupt Vector
0006–0007	Illegal Instruction Trap
0008–0037	Interrupt Vectors*
0038–003D	Oscillator Fail Traps*
003E–03FF	Program Memory

Note: *See the Trap and Interrupt Vectors in Order of Priority section on page 55 for a list of the interrupt vectors and traps.

Data Memory

Z8 Encore! XP F0823 Series does not use the eZ8 CPU's 64KB Data Memory address space.

Flash Information Area

Table 7 lists the F0823 Series Flash Information Area. This 128B Information Area is accessed by setting bit 7 of the Flash Page Select Register to 1. When access is enabled, the Flash Information Area is mapped into the Program Memory and overlays the 128 bytes at addresses FE00H to FF7FH. When the Information Area access is enabled, all reads from these Program Memory addresses return the Information Area data rather than the Program Memory data. Access to the Flash Information Area is read-only.

Table 7. F0823 Series Flash Memory Information Area Map

Program Memory Address (Hex)	Function
FE00–FE3F	Zilog Option Bits.
FE40–FE53	Part Number. 20-character ASCII alphanumeric code Left-justified and filled with FH.
FE54–FE5F	Reserved.
FE60–FE7F	Zilog Calibration Data.
FE80–FFFF	Reserved.

Table 8. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No.
GPIO Port B (cont'd)				
FD6	Port B Input Data	PBIN	XX	43
FD7	Port B Output Data	PBOUT	00	43
GPIO Port C				
FD8	Port C Address	PCADDR	00	40
FD9	Port C Control	PCCTL	00	42
FDA	Port C Input Data	PCIN	XX	43
FDB	Port C Output Data	PCOUT	00	43
FDC–FEF	Reserved	—	XX	
Watchdog Timer (WDT)				
FF0	Reset Status	RSTSTAT	XX	94
	Watchdog Timer Control	WDTCTL	XX	94
FF1	Watchdog Timer Reload Upper Byte	WDTU	FF	95
FF2	Watchdog Timer Reload High Byte	WDTH	FF	95
FF3	Watchdog Timer Reload Low Byte	WDTL	FF	95
FF4–FF5	Reserved	—	XX	
Trim Bit Control				
FF6	Trim Bit Address	TRMADR	00	148
FF7	Trim Data	TRMDR	XX	149
Flash Memory Controller				
FF8	Flash Control	FCTL	00	141
FF8	Flash Status	FSTAT	00	142
FF9	Flash Page Select	FPS	00	143
	Flash Sector Protect	FPROT	00	144
FFA	Flash Programming Frequency High Byte	FFREQH	00	145
FFB	Flash Programming Frequency Low Byte	FFREQL	00	145

Note: XX=Undefined.

clock and reset signals, the required reset duration can be as short as three clock periods and as long as four. A reset pulse three clock cycles in duration might trigger a reset; a pulse four cycles in duration always triggers a reset.

While the $\overline{\text{RESET}}$ input pin is asserted Low, the Z8 Encore! XP F0823 Series devices remain in the Reset state. If the $\overline{\text{RESET}}$ pin is held Low beyond the System Reset time-out, the device exits the Reset state on the system clock rising edge following $\overline{\text{RESET}}$ pin deassertion. Following a System Reset initiated by the external $\overline{\text{RESET}}$ pin, the EXT status bit in the WDT Control (WDTCTL) register is set to 1.

External Reset Indicator

During System Reset or when enabled by the GPIO logic (see **the** Port A–C Control Registers **section on page 42**), the $\overline{\text{RESET}}$ pin functions as an open-drain (active Low) reset mode indicator in addition to the input functionality. This reset output feature allows an Z8 Encore! XP F0823 Series device to reset other components to which it is connected, even if that reset is caused by internal sources such as POR, VBO, or WDT events.

After an internal reset event occurs, the internal circuitry begins driving the $\overline{\text{RESET}}$ pin Low. The $\overline{\text{RESET}}$ pin is held Low by the internal circuitry until the appropriate delay listed in Table 9 has elapsed.

On-Chip Debugger Initiated Reset

A POR is initiated using the On-Chip Debugger by setting the RST bit in the OCD Control Register. The OCD block is not reset but the rest of the chip goes through a normal system reset. The RST bit automatically clears during the System Reset. Following the System Reset, the POR bit in the Reset Status (RSTSTAT) Register is set.

Stop Mode Recovery

The device enters into STOP Mode when eZ8 CPU executes a `STOP` instruction. For more details about STOP Mode, see **the** Low-Power Modes **section on page 30**. During Stop Mode Recovery, the CPU is held in reset for 66 IPO cycles if the crystal oscillator is disabled or 5000 cycles if it is enabled. The SMR delay also included the time required to start up the IPO.

Stop Mode Recovery does not affect on-chip registers other than the Watchdog Timer Control Register (WDTCTL) and the Oscillator Control Register (OSCCTL). After any Stop Mode Recovery, the IPO is enabled and selected as the system clock. If another system clock source is required or IPO disabling is required, the Stop Mode Recovery code must reconfigure the oscillator control block such that the correct system clock source is enabled and selected.

PC[2:0]. All other signal pins are 5V-tolerant, and can safely handle inputs higher than V_{DD} even with the pull-ups enabled.

External Clock Setup

For systems using an external TTL drive, PB3 is the clock source for 20- and 28-pin devices. In this case, configure PB3 for alternate function CLKIN. Write the Oscillator Control Register (see the Oscillator Control Register Definitions section on page 171) such that the external oscillator is selected as the system clock. For 8-pin devices, use PA1 instead of PB3.

GPIO Interrupts

Many of the GPIO port pins are used as interrupt sources. Some port pins are configured to generate an interrupt request on either the rising edge or falling edge of the pin input signal. Other port pin interrupt sources generate an interrupt when any edge occurs (both rising and falling). For more information about interrupts using the GPIO pins, see the Interrupt Controller chapter on page 54.

GPIO Control Register Definitions

Four registers for each port provide access to GPIO control, input data, and output data. Table 18 lists these port registers. Use the Port A–D Address and Control registers together to provide access to subregisters for port configuration and control.

Table 18. GPIO Port Registers and Subregisters

Port Register Mnemonic	Port Register Name
P*x*ADDR	Port A–C Address Register (Selects subregisters).
P*x*CTL	Port A–C Control Register (Provides access to subregisters).
P*x*IN	Port A–C Input Data Register.
P*x*OUT	Port A–C Output Data Register.
Port Subregister Mnemonic	**Port Register Name**
P*x*DD	Data Direction.
P*x*AF	Alternate Function.
P*x*OC	Output Control (Open-Drain).

Table 35. Trap and Interrupt Vectors in Order of Priority

Priority	Program Memory Vector Address	Interrupt or Trap Source
Highest	0002H	Reset (not an interrupt)
	0004H	Watchdog Timer (see the Watchdog Timer section on page 91)
	003AH	Primary Oscillator Fail Trap (not an interrupt)
	003CH	Watchdog Timer Oscillator Fail Trap (not an interrupt)
	0006H	Illegal Instruction Trap (not an interrupt)
	0008H	Reserved
	000AH	Timer 1
	000CH	Timer 0
	000EH	UART 0 receiver
	0010H	UART 0 transmitter
	0012H	Reserved
	0014H	Reserved
	0016H	ADC
	0018H	Port A Pin 7, selectable rising or falling input edge
	001AH	Port A Pin 6, selectable rising or falling input edge or Comparator Output
	001CH	Port A Pin 5, selectable rising or falling input edge
	001EH	Port A Pin 4, selectable rising or falling input edge
	0020H	Port A Pin 3 or Port D Pin 3, selectable rising or falling input edge
	0022H	Port A Pin 2 or Port D Pin 2, selectable rising or falling input edge
	0024H	Port A Pin 1, selectable rising or falling input edge
	0026H	Port A Pin 0, selectable rising or falling input edge
	0028H	Reserved
	002AH	Reserved
	002CH	Reserved
	002EH	Reserved
	0030H	Port C Pin 3, both input edges
	0032H	Port C Pin 2, both input edges
	0034H	Port C Pin 1, both input edges
	0036H	Port C Pin 0, both input edges
Lowest	0038H	Reserved

1. Write to the Timer Control Register to:
   - Disable the timer
   - Configure the timer for CONTINUOUS Mode
   - Set the prescale value
   - If using the Timer Output alternate function, set the initial output level (High or Low)
2. Write to the Timer High and Low Byte registers to set the starting count value (usually `0001H`). This action only affects the first pass in CONTINUOUS Mode. After the first timer reload in CONTINUOUS Mode, counting always begins at the reset value of `0001H`.
3. Write to the Timer Reload High and Low Byte registers to set the reload value.
4. Enable the timer interrupt (if appropriate) and set the timer interrupt priority by writing to the relevant interrupt registers.
5. Configure the associated GPIO port pin (if using the Timer Output function) for the Timer Output alternate function.
6. Write to the Timer Control Register to enable the timer and initiate counting.

In CONTINUOUS Mode, the system clock always provides the timer input. The timer period is computed via the following equation:

$$\text{CONTINUOUS Mode Time-Out Period (s)} = \frac{\text{Reload Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

If an initial starting value other than `0001H` is loaded into the Timer High and Low Byte registers, use the ONE-SHOT Mode equation to determine the first time-out period.

COUNTER Mode

In COUNTER Mode, the timer counts input transitions from a GPIO port pin. The timer input is taken from the GPIO port pin Timer Input alternate function. The `TPOL` bit in the Timer Control Register selects whether the count occurs on the rising edge or the falling edge of the timer input signal. In COUNTER Mode, the prescaler is disabled.

! **Caution:** The input frequency of the timer input signal must not exceed one-fourth the system clock frequency.

Upon reaching the reload value stored in the Timer Reload High and Low Byte registers, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to `0001H` and counting resumes. Also, if the Timer Output alternate function is

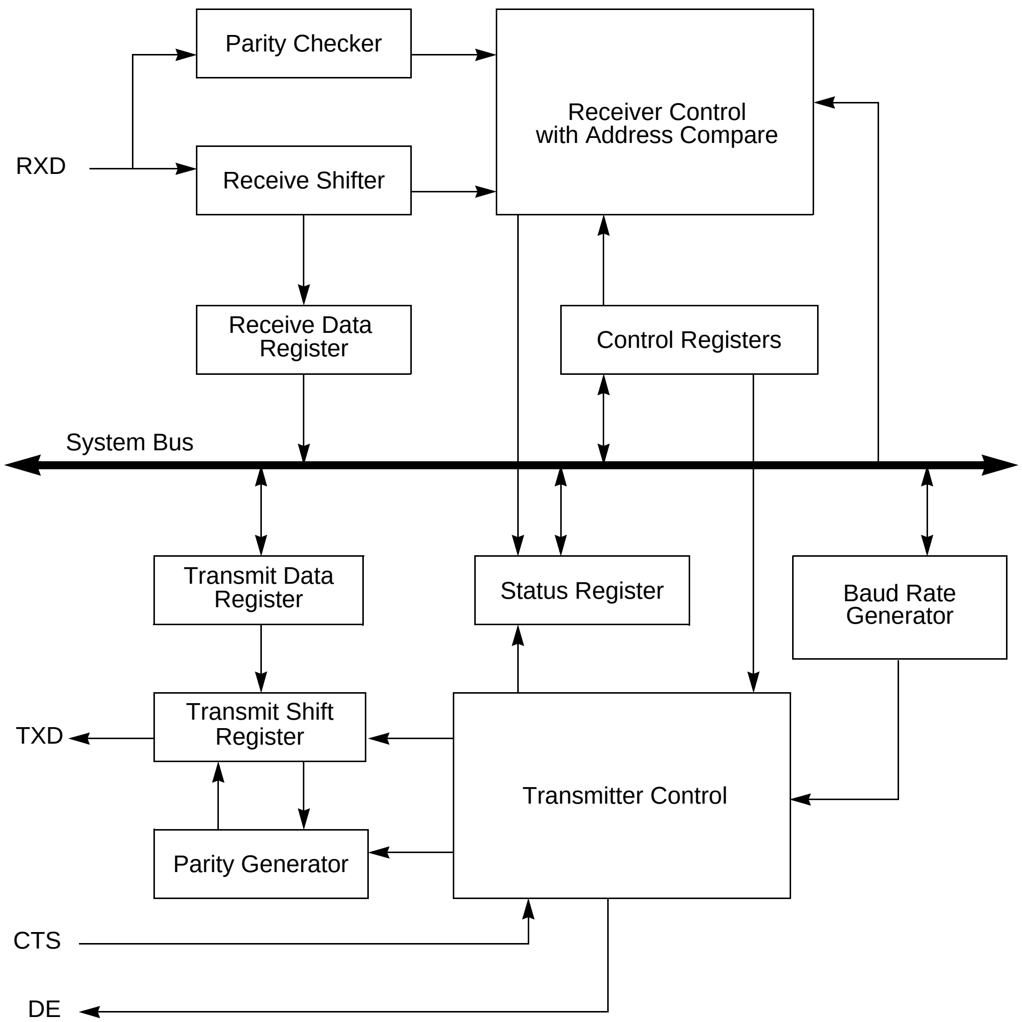

Figure 10. UART Block Diagram

Operation

The UART always transmits and receives data in an 8-bit data format, least-significant bit (lsb) first. An even or odd parity bit can be added to the data stream. Each character begins with an active Low Start bit and ends with either 1 or 2 active High Stop bits. Figure 11 and Figure 12 display the asynchronous data format employed by the UART without parity and with parity, respectively.

scheme, except that there are no interrupts on address bytes. The first data byte of each frame remains accompanied by a NEWFRM assertion.

External Driver Enable

The UART provides a Driver Enable (DE) signal for off-chip bus transceivers. This feature reduces the software overhead associated with using a GPIO pin to control the transceiver when communicating on a multi-transceiver bus, such as RS-485.

Driver Enable is an active High signal that envelopes the entire transmitted data frame including parity and Stop bits as displayed in Figure 14. The Driver Enable signal asserts when a byte is written to the UART Transmit Data Register. The Driver Enable signal asserts at least one UART bit period and no greater than two UART bit periods before the Start bit is transmitted. This allows a setup time to enable the transceiver. The Driver Enable signal deasserts one system clock period after the final Stop bit is transmitted. This one system clock delay allows both time for data to clear the transceiver before disabling it, as well as the ability to determine if another character follows the current character. In the event of back to back characters (new data must be written to the Transmit Data Register before the previous character is completely transmitted) the DE signal is not deasserted between characters. The DEPOL bit in the UART Control Register 1 sets the polarity of the Driver Enable signal.

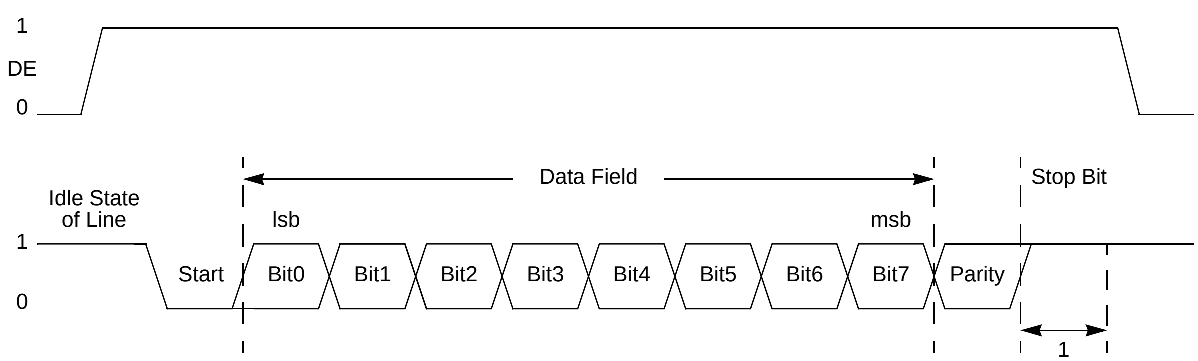

Figure 14. UART Driver Enable Signal Timing (shown with 1 Stop Bit and Parity)

The Driver Enable to Start bit setup time is calculated as follows:

UART Interrupts

The UART features separate interrupts for the transmitter and the receiver. In addition, when the UART primary functionality is disabled, the Baud Rate Generator can also function as a basic timer with interrupt capability.

Receiving IrDA Data

Data received from the infrared transceiver using the IR_RXD signal through the RXD pin is decoded by the infrared endec and passed to the UART. The UART's baud rate clock is used by the infrared endec to generate the demodulated signal (RXD) that drives the UART. Each UART/Infrared data bit is 16-clocks wide. Figure 18 displays data reception. When the infrared endec is enabled, the UART's RXD signal is internal to the Z8 Encore! XP F0823 Series products while the IR_RXD signal is received through the RXD pin.

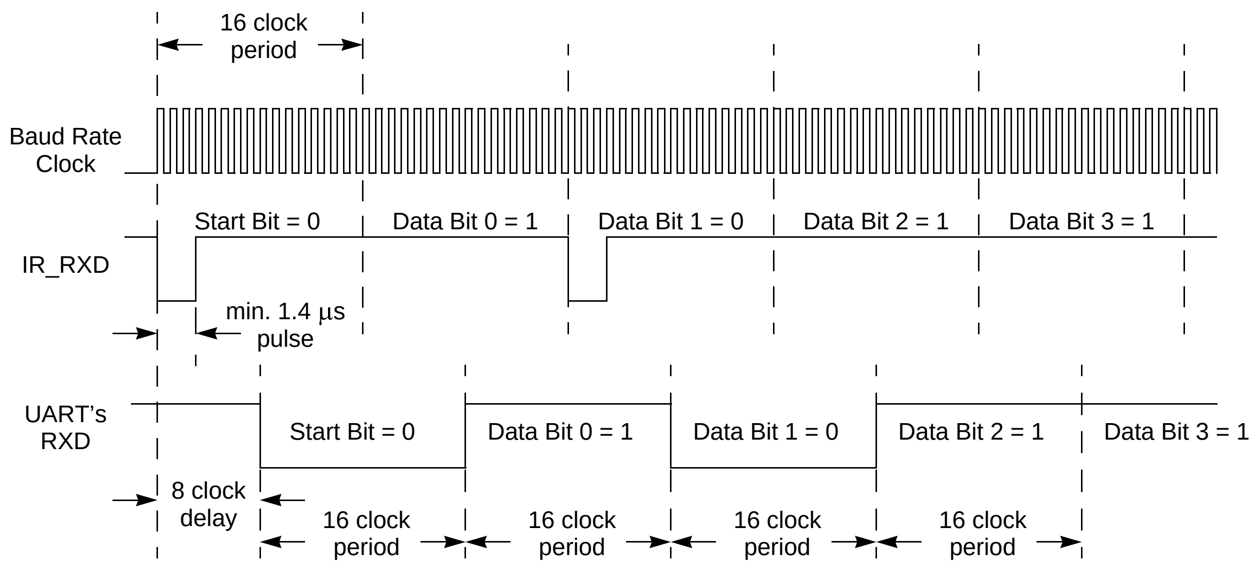

Figure 18. IrDA Data Reception

Infrared Data Reception

> **!** **Caution:** The system clock frequency must be at least 1.0 MHz to ensure proper reception of the 1.4 µs minimum width pulses allowed by the IrDA standard.

Endec Receiver Synchronization

The IrDA receiver uses a local baud rate clock counter (0 to 15 clock periods) to generate an input stream for the UART and to create a sampling window for detection of incoming pulses. The generated UART input (UART RXD) is delayed by 8 baud rate clock periods with respect to the incoming IrDA data stream. When a falling edge in the input data stream is detected, the endec counter is reset. When the count reaches a value of 8, the UART RXD value is updated to reflect the value of the decoded data. When the count reaches 12 baud clock periods, the sampling window for the next incoming pulse opens.

Comparator Control Register Definition

The Comparator Control Register (CMPCTL) configures the comparator inputs and sets the value of the internal voltage reference.

Table 78. Comparator Control Register (CMP0)

Bit	**7**	**6**	**5**	**4**	**3**	**2**	**1**	**0**
Field	INPSEL	INNSEL	REFLVL				Reserved	
RESET	0	0	0	1	0	1	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F90H							

Bit	Description
[7] INPSEL	**Signal Select for Positive Input** 0 = GPIO pin used as positive comparator input. 1 = temperature sensor used as positive comparator input.
[6] INNSEL	**Signal Select for Negative Input** 0 = internal reference disabled, GPIO pin used as negative comparator input. 1 = internal reference enabled as negative comparator input.
[5:2] REFLVL	**Internal Reference Voltage Level** 0000 = 0.0V. 0001 = 0.2V. 0010 = 0.4V. 0011 = 0.6V. 0100 = 0.8V. 0101 = 1.0V (Default). 0110 = 1.2V. 0111 = 1.4V. 1000 = 1.6V. 1001 = 1.8V. 1010–1111 = Reserved. **Note:** This reference is independent of the ADC voltage reference.
[1:0]	**Reserved** These bits are reserved; R/W bits must be programmed to 00 during writes and to 00 when read.

Flash Status Register

The Flash Status Register indicates the current state of the Flash Controller. This register can be read at any time. The read-only Flash Status Register shares its Register File address with the write-only Flash Control Register.

Table 82. Flash Status Register (FSTAT)

Bit	7	6	5	4	3	2	1	0
Field	Reserved		FSTAT					
RESET	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R	R	R
Address	FF8H							

Bit	Description
[7:6]	**Reserved** These bits are reserved and must be programmed to 0 when read.
[5:0] FSTAT	**Flash Controller Status** 000000 = Flash Controller locked. 000001 = First unlock command received (73H written). 000010 = Second unlock command received (8CH written). 000011 = Flash Controller unlocked. 000100 = Sector protect register selected. 001xxx = Program operation in progress. 010xxx = Page erase operation in progress. 100xxx = Mass erase operation in progress.

Flash Page Select Register

The Flash Page Select (FPS) register shares address space with the Flash Sector Protect Register. Unless the Flash controller is unlocked and written with `5EH`, writes to this address target the Flash Page Select Register.

The register is used to select one of the eight available Flash memory pages to be programmed or erased. Each Flash Page contains 512 bytes of Flash memory. During a Page Erase operation, all Flash memory having addresses with the most significant 7-bits given by FPS[6:0] are chosen for program/erase operation.

Table 83. Flash Page Select Register (FPS)

Bit	7	6	5	4	3	2	1	0
Field	INFO_EN	PAGE						
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FF9H							

Bit	Description
[7] INFO_EN	**Information Area Enable** 0 = Information Area us not selected. 1 = Information Area is selected. The Information Area is mapped into the Program Memory address space at addresses FE00H through FFFFH.
[6:0] PAGE	**Page Select** This 7-bit field identifies the Flash memory page for Page Erase and page unlocking. • Program Memory Address[15:9] = PAGE[6:0]. • For Z8F04x3 devices, the upper 4 bits must always be 0. • For Z8F02x3 devices, the upper 5 bits must always be 0. • For Z8F01x3 devices, the upper 6 bits must always be 0.

These serial numbers are stored in the Flash information page (for more details, see the Reading the Flash Information Page section on page 148 and the Serialization Data section on page 154) and are unaffected by mass erasure of the device's Flash memory.

Randomized Lot Identification Bits

As an optional feature, Zilog is able to provide a factory-programmed random lot identifier. With this feature, all devices in a given production lot are programmed with the same random number. This random number is uniquely regenerated for each successive production lot and is not likely to be repeated.

The randomized lot identifier is a 32-byte binary value, stored in the flash information page (for more details, see the Reading the Flash Information Page section on page 148 and the Randomized Lot Identifier section on page 154) and is unaffected by mass erasure of the device's flash memory.

Reading the Flash Information Page

The following code example shows how to read data from the Flash Information Area.

```
; get value at info address 60 (FE60h)
ldx FPS, #%80 ; enable access to flash info page
ld R0, #%FE
ld R1, #%60
ldc R2, @RR0 ; R2 now contains the calibration value
```

Flash Option Bit Control Register Definitions

This section briefly describes the features of the Trim Bit Address and Data registers.

Trim Bit Address Register

The Trim Bit Address (TRMADR) Register contains the target address for an access to the trim option bits.

Table 87. Trim Bit Address Register (TRMADR)

Bit	7	6	5	4	3	2	1	0
Field	TRMADR: Trim Bit Address (00H to 1FH)							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FF6H							

Bit	Description (Continued)
[3] VBO_AO	**Voltage Brown-Out Protection Always ON** 0 = Voltage Brown-Out Protection can be disabled in STOP Mode to reduce total power consumption. For the block to be disabled, the power control register bit must also be written (see the Power Control Register 0 section on page 31). 1 = Voltage Brown-Out Protection is always enabled including during STOP Mode. This setting is the default for unprogrammed (erased) Flash.
[2] FRP	**Flash Read Protect** 0 = User program code is inaccessible. Limited control features are available through the On-Chip Debugger. 1 = User program code is accessible. All On-Chip Debugger commands are enabled. This setting is the default for unprogrammed (erased) Flash.
[1]	**Reserved** This bit is reserved and must be programmed to 1.
[0] FWP	**Flash Write Protect** This Option Bit provides Flash Program Memory protection: 0 = Programming and erasure disabled for all of Flash Program Memory. Programming, Page Erase, and Mass Erase through User Code is disabled. Mass Erase is available using the On-Chip Debugger. 1 = Programming, Page Erase, and Mass Erase are enabled for all of Flash program memory.

Table 90. Flash Options Bits at Program Memory Address 0001H

Bit	7	6	5	4	3	2	1	0
Field	Reserved			XTLDIS	Reserved			
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Program Memory 0001H							
Note: U = Unchanged by Reset. R/W = Read/Write.								

! **Caution:** Unintentional accesses to the Oscillator Control Register can actually stop the chip by switching to a non-functioning oscillator. To prevent this condition, the oscillator control block employs a register unlocking/locking scheme.

OSC Control Register Unlocking/Locking

To write to the Oscillator Control Register, unlock it by making two writes to the OSCCTL Register with the values `E7H` followed by `18H`. A third write to the OSCCTL Register changes the value of the actual register and returns the register to a locked state. Any other sequence of Oscillator Control Register writes has no effect. The values written to unlock the register must be ordered correctly, but are not necessarily consecutive. It is possible to write to or read from other registers within the unlocking/locking operation.

When selecting a new clock source, the primary oscillator failure detection circuitry and the Watchdog Timer oscillator failure circuitry must be disabled. If POFEN and WOFEN are not disabled prior to a clock switch-over, it is possible to generate an interrupt for a failure of either oscillator. The Failure detection circuitry can be enabled anytime after a successful write of OSCSEL in the Oscillator Control Register.

The internal precision oscillator is enabled by default. If the user code changes to a different oscillator, it is appropriate to disable the IPO for power savings. Disabling the IPO does not occur automatically.

Clock Failure Detection and Recovery

Should an oscillator or timer fail, there are methods of recovery, as this section describes.

Primary Oscillator Failure

Z8 Encore! XP F0823 Series devices can generate non-maskable interrupt-like events when the primary oscillator fails. To maintain system function in this situation, the clock failure recovery circuitry automatically forces the Watchdog Timer oscillator to drive the system clock. The Watchdog Timer oscillator must be enabled to allow the recovery. Although this oscillator runs at a much slower speed than the original system clock, the CPU continues to operate, allowing execution of a clock failure vector and software routines that either remedy the oscillator failure or issue a failure alert. This automatic switch-over is not available if the Watchdog Timer is the primary oscillator. It is also unavailable if the Watchdog Timer oscillator is disabled, though it is not necessary to enable the Watchdog Timer reset function outlined in the the Watchdog Timer section on page 91.

The primary oscillator failure detection circuitry asserts if the system clock frequency drops below 1kHz ±50%. If an external signal is selected as the system oscillator, it is possible that a very slow but non-failing clock can generate a failure condition. Under these

Table 115. Logical Instructions

Mnemonic	Operands	Instruction
AND	dst, src	Logical AND
ANDX	dst, src	Logical AND using Extended Addressing
COM	dst	Complement
OR	dst, src	Logical OR
ORX	dst, src	Logical OR using Extended Addressing
XOR	dst, src	Logical Exclusive OR
XORX	dst, src	Logical Exclusive OR using Extended Addressing

Table 116. Program Control Instructions

Mnemonic	Operands	Instruction
BRK	—	On-Chip Debugger Break
BTJ	p, bit, src, DA	Bit Test and Jump
BTJNZ	bit, src, DA	Bit Test and Jump if Non-Zero
BTJZ	bit, src, DA	Bit Test and Jump if Zero
CALL	dst	Call Procedure
DJNZ	dst, src, RA	Decrement and Jump Non-Zero
IRET	—	Interrupt Return
JP	dst	Jump
JP cc	dst	Jump Conditional
JR	DA	Jump Relative
JR cc	DA	Jump Relative Conditional
RET	—	Return
TRAP	vector	Software Trap

Table 117. Rotate and Shift Instructions

Mnemonic	Operands	Instruction
BSWAP	dst	Bit Swap
RL	dst	Rotate Left
RLC	dst	Rotate Left through Carry

Electrical Characteristics

The data in this chapter represents all known data prior to qualification and characterization of the F0823 Series of products, and is therefore subject to change. Additional electrical characteristics may be found in the individual chapters of this document.

Absolute Maximum Ratings

Stresses greater than those listed in Table 120 may cause permanent damage to the device. These ratings are stress ratings only. Operation of the device at any condition outside those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For improved reliability, tie unused inputs to one of the supply voltages (V_{DD} or V_{SS}).

Table 120. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	–40	+105	°C	
Storage temperature	–65	+150	°C	
Voltage on any pin with respect to V_{SS}	–0.3	+5.5	V	1
	–0.3	+3.9	V	2
Voltage on V_{DD} pin with respect to V_{SS}	–0.3	+3.6	V	
Maximum current on input and/or inactive output pin	–5	+5	µA	
Maximum output current from active output pin	–25	+25	mA	
8-pin Packages Maximum Ratings at 0°C to 70°C				
Total power dissipation		220	mW	
Maximum current into V_{DD} or out of V_{SS}		60	mA	
20-pin Packages Maximum Ratings at 0°C to 70°C				
Total power dissipation		430	mW	
Maximum current into V_{DD} or out of V_{SS}		120	mA	
28-pin Packages Maximum Ratings at 0°C to 70°C				
Total power dissipation		450	mW	
Maximum current into V_{DD} or out of V_{SS}		125	mA	

Notes: Operating temperature is specified in DC Characteristics.
1. This voltage applies to all pins except the following: V_{DD}, AV_{DD}, pins supporting analog input (Port B[5:0], Port C[2:0]) and pins supporting the crystal oscillator (PA0 and PA1). On the 8-pin packages, this applies to all pins but V_{DD}.
2. This voltage applies to pins on the 20/28 pin packages supporting analog input (Port B[5:0], Port C[2:0]) and pins supporting the crystal oscillator (PA0 and PA1).

DC Characteristics

Table 121 lists the DC characteristics of the Z8 Encore! XP F0823 Series products. All voltages are referenced to V_{SS}, the primary system ground.

Table 121. DC Characteristics

		T_A = –40°C to +105°C (unless otherwise specified)				
Symbol	**Parameter**	**Minimum**	**Typical**	**Maximum**	**Units**	**Conditions**
V_{DD}	Supply Voltage	2.7	–	3.6	V	
V_{IL1}	Low Level Input Voltage	–0.3	–	0.3*V_{DD}	V	
V_{IH1}	High Level Input Voltage	0.7*V_{DD}	–	5.5	V	For all input pins without analog or oscillator function. For all signal pins on the 8-pin devices. Programmable pull-ups must also be disabled.
V_{IH2}	High Level Input Voltage	0.7*V_{DD}	–	V_{DD}+0.3	V	For those pins with analog or oscillator function (20-/28-pin devices only), or when programmable pull-ups are enabled.
V_{OL1}	Low Level Output Voltage	–	–	0.4	V	I_{OL} = 2mA; V_{DD} = 3.0V High Output Drive disabled.
V_{OH1}	High Level Output Voltage	2.4	–	–	V	I_{OH} = –2mA; V_{DD} = 3.0V High Output Drive disabled.
V_{OL2}	Low Level Output Voltage	–	–	0.6	V	I_{OL} = 20mA; V_{DD} = 3.3 V High Output Drive enabled.
V_{OH2}	High Level Output Voltage	2.4	–	–	V	I_{OH} = –20mA; V_{DD} = 3.3 V High Output Drive enabled.
I_{IH}	Input Leakage Current	–	±0.002	±5	µA	V_{IN} = V_{DD} V_{DD} = 3.3 V
I_{IL}	Input Leakage Current	–	±0.007	±5	µA	V_{IN} = V_{SS} V_{DD} = 3.3 V
I_{TL}	Tristate Leakage Current	–	–	±5	µA	

Notes:
1. This condition excludes all pins that have on-chip pull-ups, when driven Low.
2. These values are provided for design guidance only and are not tested in production.

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